A.3 Specifications of S3-4K

S3-4K Specifications

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Genlock	Analog reference input/loop on BNC connectors; bi-level and blackburst at SD and tri-level at HD
	S3D Sync: 4x input Din connector, 2x output Din connector
Program output	4 program outputs configurable as single screens or tiled/blended widescreens
	Configurable from 4X 2048X1200@60 max to 1 x 4096x2400@60 max
	Independent edge blending/feathering control for all four sides
Scaled Aux outputs	User definable from 4 x 2048x1200@60 to 1 x 4K@60
	Output color correction
Mixers	Cathat color correction
MINCIS	Native resolution background mixer per output screen
	Independent layer transitions or full Preview/Program transition
	Flexible layer allocation – 4 mixable or 8 single scalable PIP/key layers assignable to any Program output screen
Video inputs	12 inputs via 3 input cards (Event Master series cards)
	Up to 3 x 4K inputs - each input card supports up to 4K@60p
	4 x SD/HD/3G SDI (6G ready)
	4 x HDMI 1.4a (297 Mpix/sec max)
	4 x DisplayPort 1.1 (330 Mpix/sec max)
Video outputs	10 outputs via 3 output cards (Event Master series cards)
	Up to 2x 4K outputs - each output card supports up to 4K@60 p
	4 x SD/HD/3G SDI (6G ready)
	4x HDMI 1.4a (297 Mpix/sec max)
	2 x HDMI 1.4a for Multiviewer (297 Mpix/sec max)
Still stores	Up to 100 HD stills available in background, Aux or PIP
Layer effects	
	 Borders (hard, soft, halo) and drop shadows Color effects
	Strobe, H&V flip
	• Luma key
	PIP moves via Keyframes
Multiviewer	,
	Flexible user-definable layouts
	Monitor all Inputs and Outputs, including Preview and Aux
	Two outputs
	Dedicated hardware same as E2 Event Master Processor
Expandability	Facily avandable for larger display applications via proprietory links
	 Easily expandable for larger display applications via proprietary links Link units to increase available Inputs and Outputs for larger tiled/blended
	widescreen applications
	Expansion via simple linking - up to 4 chassis
	S3-4K ships with the ability to link 2 chassis for expansion. Linking up to 4 chassis will be available in a future software release.
HDCP	HDCP compliant
Control	
	Event Master screen management software for PC or MAC
	Ethernet RJ-45, 1000/100/10 Mbps autosense
Serviceability	Field Comissoable I/O and managed from the second live to the second l
	Field-Serviceable I/O and processing cards (not hot-swappable)
	Hot-swappable dual-redundant power supplies

Dimensions	 Height: 13.26 cm (5.22 in) - 3 rack mount units Width: 43.2 cm (17 in) without chassis handles, 48.3 cm (19 in) with chassis handles attached Depth: 54 cm (21.33 in) overall
Weight	24 kg / 53 lbs
Power	 Input power: 100-240 VAC 50/60Hz 700W Dual-redundant, hot-swappable power supplies; same as E2 Event Master processor
Environmental temperature	0-40° C / 32-104 F
Environmental humidity	0-95% non-condensing
Warranty	3 years parts and labor